

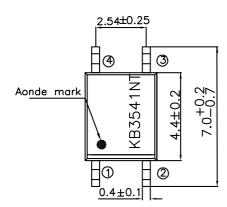
Features

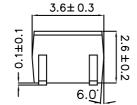
- 1.AC inputs
- 2. High current transfer ratio
- 3. Opaque type, mini-flat package
- 4. Subminiature type (The volume is smaller than that of our conventional DIP type by as far as 30%)
- 5.Isolation voltage between input and output Viso:3750Vrms
- 6. Employs double transfer mold technology
- 7.Recognized by UL and CUL, file NO.E225308.
- 8.Package:1000Pcs/Reel.
- 9.RoHS Compliant.

Applications

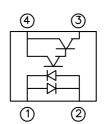
- 1. Hybrid substrates that require high density mounting
- 2. Programmable controllers

*PACKAGE DIMENSIONS (UNIT:mm) SMD Type

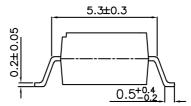




Internal connection diagram



- 1 Anode/Cathode Emitter
- (2) Cathode/Anode (4) Collector



UNIT: MM[INCH]

TOLERANCE : $\pm 0.5[\pm 0.02]$ UNLESS OTHERWISE NOTED.

SPEC NO: DSAD2838 APPROVED: J. Lu

REV NO: V.6
CHECKED: Tracy Deng

DATE: APR/06/2005 DRAWN: Y.W.WANG PAGE: 1 OF 7 ERP:1205000036



*Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit	
Input	Forward current	lF	±50	mA	
	Power dissipation	Р	70	mW	
Output	Collector-emitter voltage	VCEO	35	V	
	Emitter-collector voltage	VECO	6	V	
	Collector current	IC	80	mA	
	Collector power dissipation	Pc	150	mW	
Total power dissipation		Ptot	170	mW	
*1 Isolation voltage		Viso	3750	Vrms	
Operating temperature		Topr	-30 to +100	°C	
Storage temperature		Tstg	-40 to +125	°C	
*2 Soldering temperature		Tsol	260	°C	

^{*1 40} to 60%RH, AC for1 minute.

*Electro-optical Characteristics

Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input	Forward voltage		VF	IF=± 20mA	-	1.2	1.4	V
	Peak forward voltage		VFM	IFM=0.5A	-	-	3.0	V
Output	Collector dark current		ICEO	Vce=20V IF=0	-	-	10 ⁻⁶	Α
	Collector-emitter breakdown voltage		BV _{CEO}	I _C =0.1mA IF=0	35	-	_	V
	Emitter-collector breakdown voltage		BV _{ECO}	I _E =10uA IF=0	6	-		V
Transfer charact- eristics	Current transfer ration		CTR	IF=± 1mA Vce=5V	450	1600	7400	%
	Collector-emitter saturation voltage		Vce (sat)	IF=± 20mA Ic=1mA	-	0.8	1.0	V
	Response time	Rise time	tr	Vce=2V Ic=2mA RL=100Ω	-	60	300	uS
		Fall time	tr			53	250	uS

SPEC NO: DSAD2838 REV NO: V.6 DATE: APR/06/2005 PAGE: 2 OF 7
APPROVED: J. Lu CHECKED: Tracy Deng DRAWN: Y.W.WANG ERP:1205000036

^{*2} For 10 seconds.



Fig. 1 Current Transfer Ratio vs. Forward Current

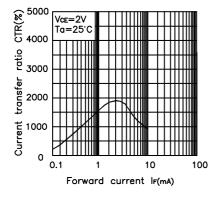


Fig. 3 Collector Current vs.

Collector-emitter Voltage

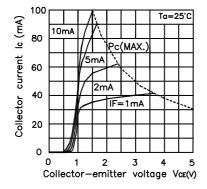


Fig. 5 Collector-emitter Saturation Voltage vs. Ambient Temperature

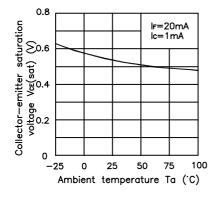


Fig. 2 Forward Current vs. Forward voltage

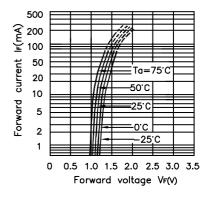


Fig. 4 Relative Current Transfer Ratio vs. Ambient Temperature

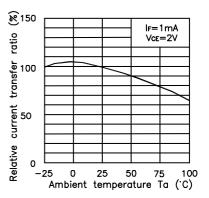
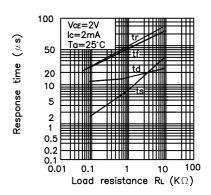


Fig. 6 Response Time vs. Load Resistance



SPEC NO: DSAD2838 APPROVED: J. Lu REV NO: V.6
CHECKED: Tracy Deng

DATE: APR/06/2005 DRAWN: Y.W.WANG PAGE: 3 OF 7

ERP:1205000036



Fig. 7 Collector-emitter Saturation Voltage vs. Forward Current

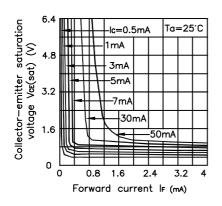
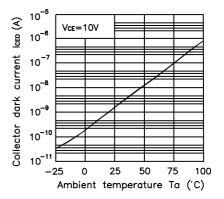
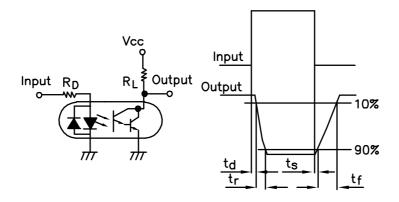


Fig. 8 Collector Dark Current vs.
Ambient Temperature



Test Circuit for Response Time



SPEC NO: DSAD2838 APPROVED: J. Lu REV NO: V.6
CHECKED: Tracy Deng

DATE: APR/06/2005 DRAWN: Y.W.WANG PAGE: 4 OF 7 ERP:1205000036



* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

(1) Dip soldering

Temperature 260 or below (molten solder temperature)

Time Less than 10 seconds.

Cycle One cycle allowed to be dipped in solder including plastic nold portion.

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(2) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen, even if the voltage is within the absolute maximum ratings.

SPEC NO: DSAD2838 REV NO: V.6 DATE: APR/06/2005 PAGE: 5 OF 7
APPROVED: J. Lu CHECKED: Tracy Deng DRAWN: Y.W.WANG ERP:1205000036



NOTES ON HANDLING

1.Recommended soldering conditions

(1).Infrared reflow soldering

Peak reflow temperature
 235 ° C or below(package surface temperature)

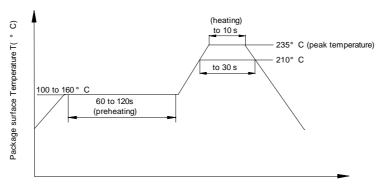
• Time of temperature higher than 210 ° C 30 seconds or less

Number or reflows
 Three

• Flux Rosin flux containing small amount of chlorine(The flux with a

maximum chlorine content of 0.2Wt $\,$ % is recommended.)

Recommended Temperature Profile of infrared Reflow



CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested.

GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

RESTRICTIONS ON PRODUCT USE

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices / types available in every country.
- We are mention about our product quality stablity, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing KINGBRIGHT products, to observe standards of safety, and to a avoid situations in which a malfunction or failure of a KINGBRIGHT product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that KINGBRIGHT products are used within specified operating ranges as set forth in the most recent products specifications.

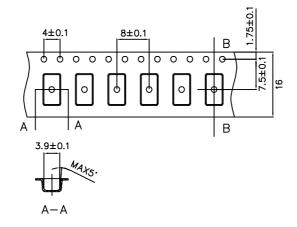
 SPEC NO: DSAD2838
 REV NO: V.6
 DATE: APR/06/2005
 PAGE: 6 OF 7

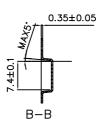
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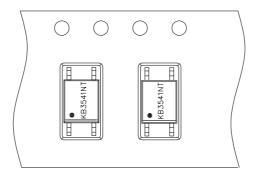
Outline and Dimension(Tape)

(Units: mm)

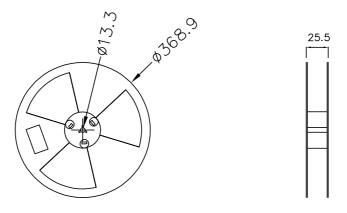




Tape Direction



Outline and Dimension(Reel)



Packing:1000pcs/reel